

DRILLING DETAILS:

## STACKUP CONFIGURATION 2 LAYER

SIGNALS+COMP. 18+35um L1 LAYER 1 (TOP SDE) 1,6mm ± 10%
SIGNALS+COMP. 18+35um L2 LAYER 2 (BOTTOM SIDE)

NOTES: (UNLESS SPECIFIED OTHERWISE.)

1) MATERIAL: FR-4-2 NATURAL EPOXY/FIBERGLASS 53UM COPPER ON ALL LAYERS. 2 SIDES PLATED.

FINISHED THICKNESS: 1,6mm ±10%

2) APPLY SOLDERMASK ON BOTH SIDES

COLOR: GREEN

FABRICATOR SHALL MAKE NECESSARY

MODFICATIONS TO SOLDERMASK PHOTOPLOT FLES
FOR OPTIMAL SOLDERMASK COVERAGE BETWEEN
FINE PITCH COMPONENT LEADS.

3) FINISH ALL EXPOSED COPPER SURFACES WITH

IMMERSION GOLD.

4) HOLE SIZES APPLY AFTER PLATING.

5) APPLY SILKSCREEN ON BOTH SIDES

COLOR: WHITE

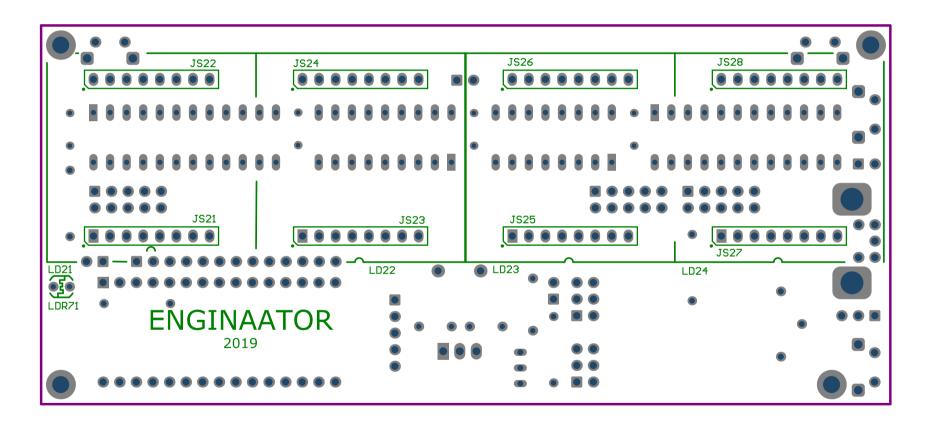
FABRICATOR SHALL MAKE NECESSARY
MODIFICATIONS TO LEGEND PHOTOPLOT FILES
TO ENSURE NO LEGEND INK COVERS ANY
COMPONENT PAD OR VIA PAD.

6) MODIFIED PHOTOPLOT FILES ARE TO BE RETURNED

BEFORE ORDER DELIVERED.

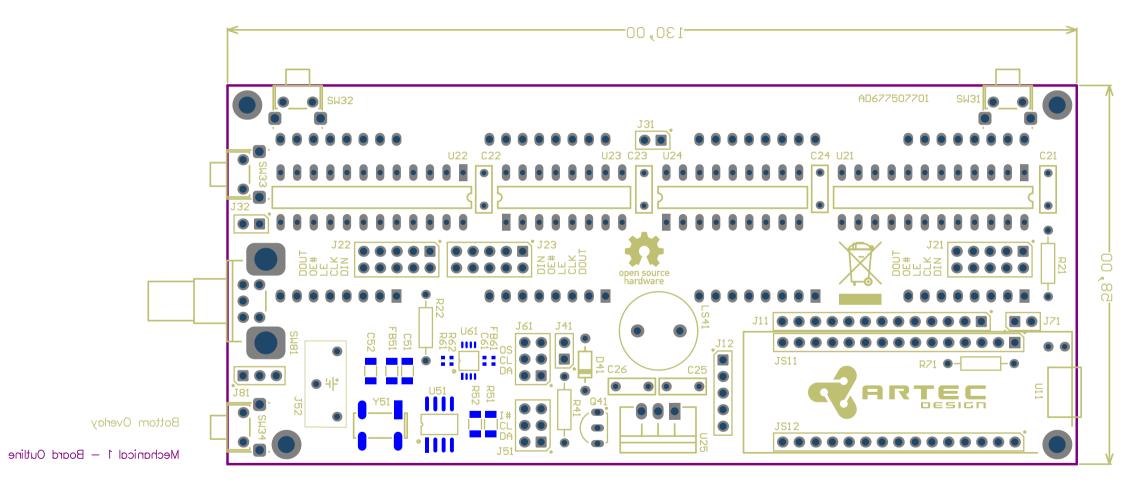
 ALL PRINTED CIRCUIT BOARD NETS SHALL BE ELECTRICALLY TESTED FOR OPENS AND SHORTS.

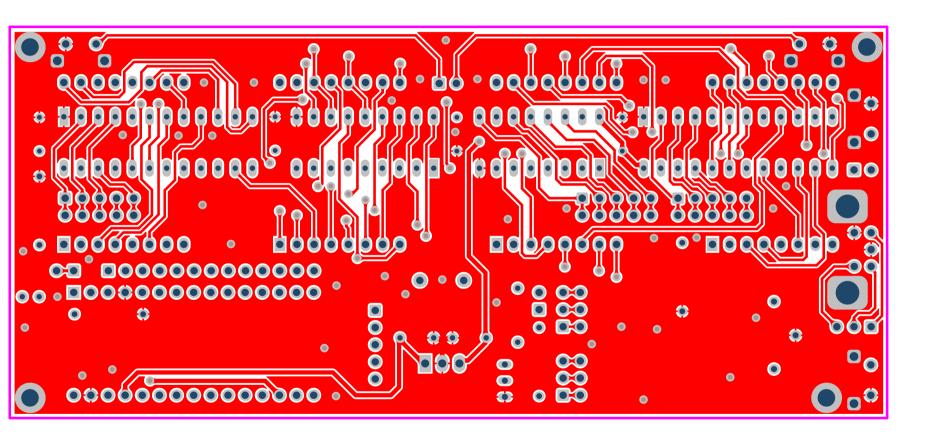
APPROVALS	DA	TE	PRTEC	Akadeemia tee 21/1, 3rd floor Tallinn 12618, Estonia, EU		
DESIGNER: Anti Sullin	04.04.2019			Tel: (+372) 671-8550		
CHECKER:	04.04.2019		Enginaator 2019 FABRICATION			
PRJ MGR: Markus Kasak	04.04.2019					
		SIZE	DRAWING NUMBER	SCALE	SHEET	VERSION
CLIENT:		A4	857507701	1:1	1 OF 1	01



Top Overlay

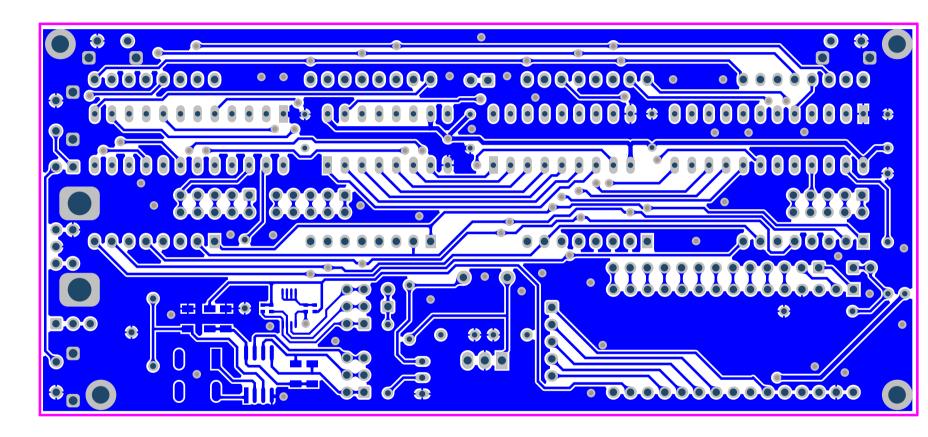
Mechanical 1 - Board Outline





Top Layer

Mechanical 1 — Board Outline



Bottom Layer

Mechanical 1 - Board Outline